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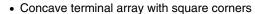


Thick Film, Resistor Array



The CRA04P thick film resistor array is constructed on a high grade ceramic body with concave terminations. A small package enables the design of high density circuits. The single component reduces board space, component counts and assembly costs.

FEATURES





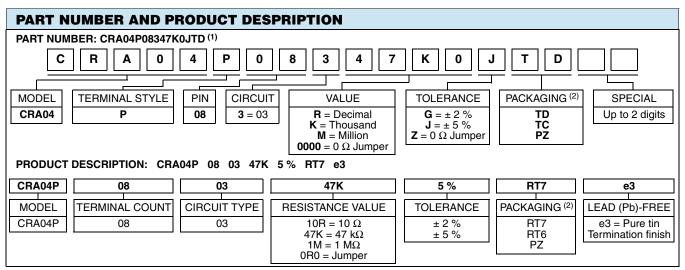
- Wide ohmic range: 1R0 to 1M0
- 8 terminal package with isolated resistors
- Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition

STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	CIRCUIT	POWER RATING P _{70 °C} W	LIMITING ELEMENT VOLTAGE MAX. V≅	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	$\begin{array}{c} \textbf{RESISTANCE} \\ \textbf{RANGE} \\ \Omega \end{array}$	E-SERIES	
	03	0.063	50	± 100	± 2	10R to 1M0	24	
CRA04P				± 200	± 5	1R0 to 1M0	24	
		Zero-Ohm-Resistor: $R_{\text{max.}} = 50 \text{ m}\Omega$, $I_{\text{max.}} = 1 \text{ A}$						

TECHNICAL SPECIFICATIONS						
PARAMETER	UNIT	CRA04P				
Rated Dissipation P ₇₀ (1)	W per element	0.063				
Limiting Element Voltage U _{max.} AC/DC	V	50				
Insulation Voltage U _{ins} (1 min)	V	100				
Insulation Resistance	Ω	> 10 ⁹				
Category Temperature Range	°C	- 55 to + 155				

Note

⁽¹⁾ Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.



Notes

- (1) Preferred way for ordering products is by use of the PART NUMBER
- (2) Please refer to the table PACKAGING, see next page

ROHS COMPLIANT HALOGEN

FREE

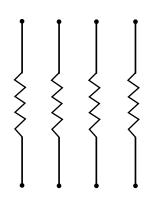


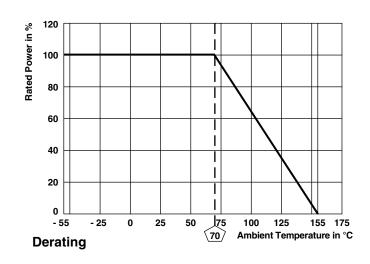
Thick Film, Resistor Array

PACKAGING								
		DIAMETER	PITCH	PIECES/REEL	PACKAGING CODE			
MODEL	TAPE WIDTH				PAPER TAPE			
					PART NUMBER	PRODUCT DESCRIPTION		
		180 mm/7"	2 mm	10 000	TD	RT7		
CRA04P	8 mm	330 mm/13"	2 mm	20 000	TC	RT6		
		330 mm/13"	2 mm	50 000	PZ	PZ		

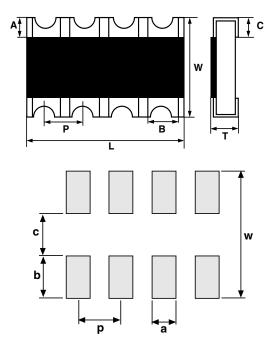
CIRCUIT

03 Circuit





DIMENSIONS



PIN NO#	DIMENSIONS (in millimeters)							
	L	Α	В	С	P _{NOM}	т	w	
8	2.00	0.20	0.32	0.25	0.50	0.45	1.00	
TOL.	± 0.20	± 0.10	± 0.10	± 0.15	-	± 0.10	± 0.10	

SOLDER PAD DIMENSIONS (in millimeters)						
	c w p a b					
WAVE	0.5	1.5	0.5	0.32	0.5	

Thick Film, Resistor Array



TEST PROCEDURES AND REQUIREMENTS								
EN 60115-1 CLAUSE IEC 60068-2 TEST METHOD		TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR) (1)				
				STABILITY CLASS 2 OR BETTER				
			Stability for product type:	10 Ω to 1 MΩ	1 Ω to 1 MΩ			
			CRA04P	10 22 10 1 10122	1 52 10 1 10152			
4.5	-	Resistance	-	± 2 %	± 5 %			
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	No flashover	or breakdown			
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max.}}$; Duration according to style	± (0.5 % F	$R + 0.05 \Omega$			
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40; non-activated flux; (235 ± 5) °C; (2 ± 0.2) s		: 95 % covered) e damage			
4.17.2	38 (Tu)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5; non-activated flux; (245 ± 5) °C; (3 ± 0.3) s		95 % covered) damage			
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K			
4.32	21 (U _{U3})	Shear (adhesion)	45 N	No visible	damage			
4.33	21 (U _{U1})	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25 \% R + 0.05 \Omega)$				
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 °C; 30 min at 125 °C 5 cycles 1000 cycles		? + 0.05 Ω) + 0.05 Ω)			
4.23	-	Dry heat	-	•	,			
4.23.2	2 (Ba)	Damp heat, cyclic	125 °C; 16 h					
4.23.3	30 (Db)	Cold	55 °C; ≥ 90 % RH; 24 h; 1 cycle					
4.23.4	1 (Aa)	Low air pressure	- 55 °C; 2 h	± (2 % R	+ 0.05 Ω)			
4.23.5	13 (M)	-	1 kPa; (25 ± 10) °C; 1 h					
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycle					
4.23.7	-	D.C. load	$U = \sqrt{P_{70} \times R}$					
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}$ 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h		? + 0.1 Ω) ? + 0.1 Ω)			
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.5 % R + 0.05 Ω)				
4.35	-	Flammability, needle flame test	IEC 60695-11-5; 10 s	No burning	g after 30 s			
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % R	+ 0.05 Ω)			
4.25.3	-	Endurance at upper category temperature	155 °C; 1000 h	± (2 % R + 0.1 Ω)				
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 positive and 3 negative discharges; ESD voltage according to style	± (1 % R	+ 0.05 Ω)			
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible	e damage			
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1; toothbrush	Marking legible, no visible damage				
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10 \text{ Hz to } 2000 \text{ Hz; x, y, z} \le 1.5 \text{ mm;}$ $A \le 200 \text{ m/s}^2; 10 \text{ sweeps per axis}$	± (0.5 % F	? + 0.05 Ω)			
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \le 2 \times U_{\text{max.}}$ 0.1 s on; 2.5 s off; 1000 cycles	± (1 % R + 0.05 Ω)				
4.27	-	Single pulse high voltage overload, 10 μs/700 μs	$\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}}$ 10 pulses	± (1 % R + 0.05 Ω)				

Note

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2 environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3

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⁽¹⁾ Figures are given for a single element



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Vishay

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